

# ECG001F

## InGaP HBT Gain Block



### Product Features

- DC – 6 GHz
- 22 dB Gain @ 1 GHz
- +12.5 dBm P1dB @1 GHz
- +25 dBm OIP3 @ 1 GHz
- 3.4 dB Noise Figure
- Internally matched to 50  $\Omega$
- Lead-free/green/RoHS-compliant SOT-363 package

### Applications

- Mobile Infrastructure
- CATV / FTTX
- W-LAN / ISM
- RFID
- WiMAX / WiBro

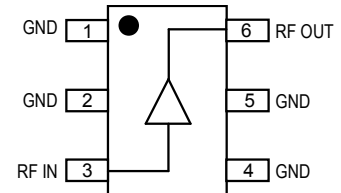
### Product Description

The ECG001F is a general-purpose buffer amplifier that offers high dynamic range in a low-cost surface-mount package. At 1000 MHz, the ECG001F typically provides 22 dB of gain, +25 dBm Output IP3, and +12.5 dBm P1dB.

The ECG001F consists of a Darlington-pair amplifier using the high reliability InGaP/GaAs HBT process technology and only requires DC-blocking capacitors, a bias resistor, and an inductive RF choke for operation. The device is ideal for wireless applications and is available in a low-cost, surface-mountable lead-free/green/RoHS-compliant SOT-363 package. All devices are 100% RF and DC tested.

The broadband MMIC amplifier can be directly applied to various current and next generation wireless technologies such as GPRS, GSM, CDMA, and W-CDMA. In addition, the ECG001F will work for other various applications within the DC to 6 GHz frequency range such as CATV and mobile wireless.

### Functional Diagram



| Function    | Pin No.    |
|-------------|------------|
| Input       | 3          |
| Output/Bias | 6          |
| Ground      | 1, 2, 4, 5 |

### Specifications <sup>(1)</sup>

| Parameter                 | Units | Min  | Typ   | Max  |
|---------------------------|-------|------|-------|------|
| Operational Bandwidth     | MHz   | DC   |       | 6000 |
| Test Frequency            | MHz   |      | 1000  |      |
| Gain                      | dB    |      | 22.2  |      |
| Output P1dB               | dBm   |      | +12.5 |      |
| Output IP3 <sup>(2)</sup> | dBm   |      | +25   |      |
| Test Frequency            | MHz   |      | 2000  |      |
| Gain                      | dB    | 19.2 | 20.7  | 21.8 |
| Input Return Loss         | dB    |      | 35    |      |
| Output Return Loss        | dB    |      | 18    |      |
| Output P1dB               | dBm   |      | +12.5 |      |
| Noise Figure              | dB    |      | 3.4   |      |
| Device Voltage            | V     | 3.0  | 3.4   | 3.8  |
| Device Current            | mA    |      | 30    |      |

1. Test conditions unless otherwise noted: 25 °C, Supply Voltage = +5 V, Rbias = 51  $\Omega$ , 50  $\Omega$  System.

### Typical Performance <sup>(1)</sup>

| Parameter                 | Units | Typical |       |       |       |
|---------------------------|-------|---------|-------|-------|-------|
| Frequency                 | MHz   | 500     | 900   | 1900  | 2140  |
| S21                       | dB    | 22.6    | 22.4  | 20.9  | 20.6  |
| S11                       | dB    | -46     | -42   | -35   | -29   |
| S22                       | dB    | -29     | -24   | -18   | -17   |
| Output P1dB               | dBm   | +12     | +12.5 | +12.5 | +12.5 |
| Output IP3 <sup>(2)</sup> | dBm   | +23     | +25   | +26   | +26   |
| Noise Figure              | dB    | 3.4     | 3.4   | 3.4   | 3.4   |

**Not Recommended For  
New Designs**  
Recommended replacement parts:  
**AG303-63G**

### Absolute Maximum Rating

| Parameter   | Rating         |
|---|----------------|
| Storage Temperature                                       | -55 to +150 °C |
| Device Current  | 150 mA         |
| RF Input Power (continuous)                               | +12 dBm        |
| Thermal Resistance, Rth<br>For 10 <sup>6</sup> hours MTTF | 270°C/W        |
| Junction Temperature                                      | +160°C         |

Operation of this device above any of these parameters may cause permanent damage.

### Ordering Information

| Part No.  | Description  |
|-----------|--|
| ECG001F-G | InGaP HBT Gain Block<br>(lead-free/green/RoHS-compliant SOT-363 package) |

Standard tape / reel size = 3000 pieces on a 7" reel

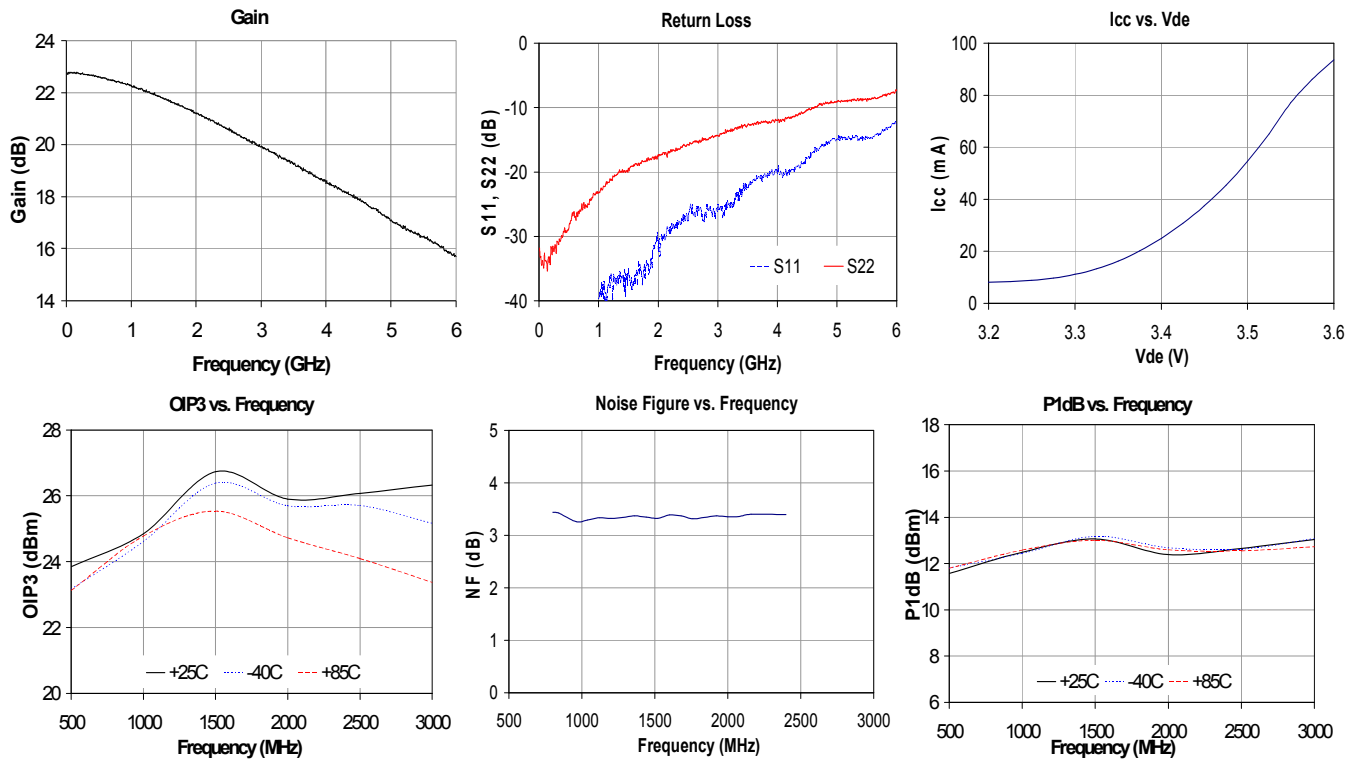
Specifications and information are subject to change without notice

### Typical Device RF Performance

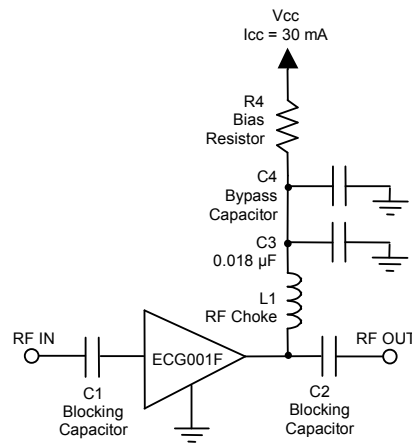
Supply Bias = +5 V,  $R_{bias} = 51 \Omega$ ,  $I_{cc} = 30 \text{ mA}$

| Frequency    | MHz | 100   | 500   | 900   | 1900  | 2140  | 2400  | 3500  | 5800 |
|--------------|-----|-------|-------|-------|-------|-------|-------|-------|------|
| S21          | dB  | 22.8  | 22.6  | 22.4  | 20.9  | 20.6  | 20.2  | 18.6  | 15.5 |
| S11          | dB  | -48   | -46   | -42   | -35   | -29   | -28   | -22   | -14  |
| S22          | dB  | -34   | -29   | -24   | -18   | -17   | -16   | -13   | -8   |
| Output P1dB  | dBm | +11.6 | +11.6 | +12.6 | +12.6 | +12.6 | +12.8 | +12.2 | +11  |
| Output IP3   | dBm | +23.6 | +23.5 | +24.8 | +26   | +25.6 | +25.4 | +23   |      |
| Noise Figure | dB  | 3.4   | 3.4   | 3.4   | 3.4   | 3.4   | 3.4   |       |      |

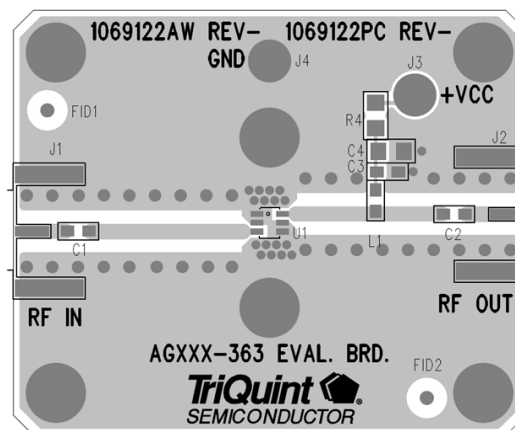
1. Test conditions:  $T = 25^\circ \text{C}$ , Supply Voltage = +5 V, Device Voltage = +3.4 V,  $R_{bias} = 51 \Omega$ ,  $I_{cc} = 30 \text{ mA}$  typical,  $50 \Omega$  System.
2. 3OIP measured with two tones at an output power of -1 dBm/line separated by 1 MHz. The suppression on the largest IM3 product is used to calculate the 3OIP using a 2:1 rule.
3. Data is shown as device performance only. Actual implementation for the desired frequency band will be determined by external components shown in the application circuit.



### Recommended Application Circuit



### ECG001F-PCB



Recommended Component Values

| Reference Designator | Frequency (MHz) |         |        |       |       |       |       |
|----------------------|-----------------|---------|--------|-------|-------|-------|-------|
|                      | 50              | 500     | 900    | 1900  | 2200  | 2500  | 3500  |
| L1                   | 820 nH          | 220 nH  | 68 nH  | 27 nH | 22 nH | 18 nH | 15 nH |
| C1, C2, C4           | .018 $\mu$ F    | 1000 pF | 100 pF | 68 pF | 68 pF | 56 pF | 39 pF |

1. The proper values for the components are dependent upon the intended frequency of operation.
2. The following values are contained on the evaluation board to achieve optimal broadband performance:

| Ref. Design. | Value / Type                 | Size |
|--------------|------------------------------|------|
| L1           | 39 nH wirewound inductor     | 0603 |
| C1, C2       | 56 pF chip capacitor         | 0603 |
| C3           | 0.018 $\mu$ F chip capacitor | 0603 |
| C4           | Do Not Place                 |      |
| R4           | 51 $\Omega$ 1% tolerance     | 0805 |

Recommended Bias Resistor Values

| Supply Voltage | R1 value  | Size |
|----------------|-----------|------|
| 5 V            | 53.3 ohms | 0805 |
| 6 V            | 86.7 ohms | 0805 |
| 8 V            | 153 ohms  | 1210 |
| 9 V            | 187 ohms  | 1210 |
| 10 V           | 220 ohms  | 2010 |
| 12 V           | 287 ohms  | 2010 |

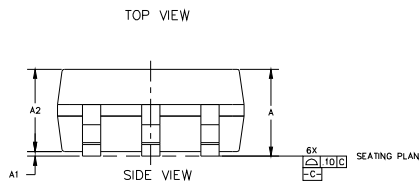
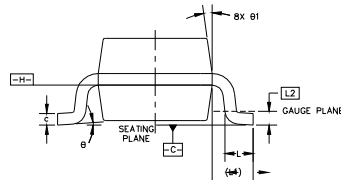
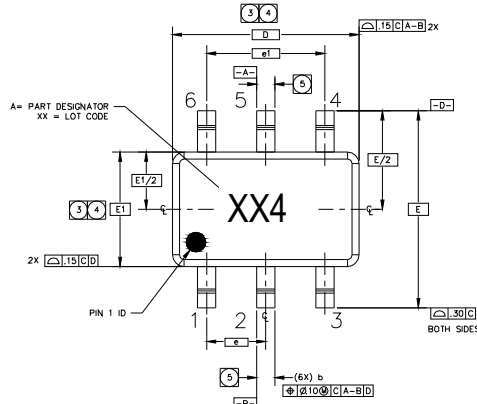
The proper value for R1 is dependent upon the supply voltage and allows for bias stability over temperature. WJ recommends a minimum supply bias of +5 V. A 1% tolerance resistor is recommended.

### ECG001F-G Mechanical Information

This package is lead-free/Green/RoHS-compliant. The plating material on the leads is annealed matte tin over copper. It is compatible with both lead-free (maximum 260 °C reflow temperature) and leaded (maximum 245 °C reflow temperature) soldering processes.

### Outline Drawing

| SYMBOL | MIN            | MAX            |
|--------|----------------|----------------|
| A      | —              | 1.10<br>(.043) |
| A1     | 0              | .10<br>(.004)  |
| A2     | .70<br>(.028)  | 1.00<br>(.039) |
| D      | 2.00<br>(.079) | BASIC          |
| E      | 2.10<br>(.083) | BASIC          |
| E1     | 1.25<br>(.039) | BASIC          |
| L      | .21<br>(.008)  | .41<br>(.016)  |
| L1     | .42<br>(.017)  | REF            |
| L2     | .15<br>(.006)  | BASIC          |
| Ø      | 0"             | 8"             |
| Ø1     | 4"             | 12"            |
| b      | .15<br>(.006)  | .30<br>(.012)  |
| c      | .08<br>(.003)  | .22<br>(.009)  |
| e      | .65<br>(.026)  | BASIC          |
| e1     | 1.30<br>(.051) | BASIC          |

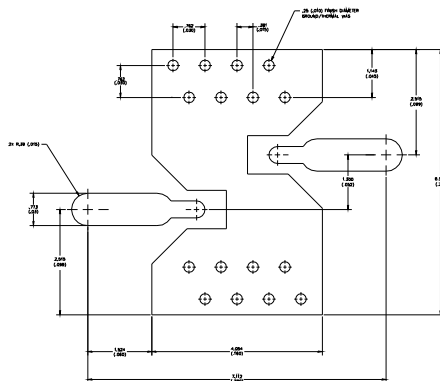


#### NOTES:

- DIMENSIONS AND TOLERANCING PER ASME Y14.5M-1194. PACKAGE CONFORMS TO JEDEC MO-203, ISSUE B.
- DIMENSIONS ARE IN MILLIMETERS (INCHES).
- DIMENSION D DOES NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS. MOLD FLASH, PROTRUSIONS OR GATE BURRS SHALL NOT EXCEED 0.15 mm PER END. DIMENSION E1 DOES NOT INCLUDE INTERLEAD FLASH OR PROTRUSION. INTERLEAD FLASH OR PROTRUSION SHALL NOT EXCEED 0.15 mm PER SIDE. D AND E1 DIMENSIONS ARE DETERMINED AT DATUM H.
- THE PACKAGE TOP MAY BE SMALLER THAN THE PACKAGE BOTTOM. DIMENSIONS D AND E1 ARE DETERMINED AT THE OUTERMOST EXTREMES OF THE PLASTIC BODY EXCLUSIVE OF MOLD FLASH, GATE BURRS, GATE BURRS AND INTERLEAD FLASH, BUT INCLUDING ANY MISMATCH BETWEEN THE TOP AND THE BOTTOM OF THE PLASTIC BODY. D AND E1 DIMENSIONS ARE DETERMINED AT DATUM H.

- DATUM A & B TO BE DETERMINED AT DATUM H.
- DIMENSION 'b' DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.08 mm TOTAL IN EXCESS OF THE 'b' DIMENSION AT MAXIMUM MATERIAL CONDITION. THE DAMBAR IS NOT LOCATED ON THE LOWER RADII OF THE FOOT. MINIMUM SPACE BETWEEN PROTRUSION AND AN ADJACENT LEAD SHALL NOT BE LESS THAN 0.07 mm.

### Land Pattern



### Product Marking

The component will be marked with a two-digit numeric lot code (shown as "XX") followed with a "4" designator on the top surface of the package.

Tape and reel specifications for this part are located on the website in the "Application Notes" section.

### MSL / ESD Rating



**Caution!** ESD sensitive device.

ESD Rating: Class 1A  
Value: Passes between 250 and 500V  
Test: Human Body Model (HBM)  
Standard: JEDEC Standard JESD22-A114

MSL Rating: Level 3 at +260 °C convection reflow  
Standard: JEDEC Standard J-STD-020

### Mounting Config. Notes

- Ground / thermal vias are critical for the proper performance of this device. Vias should use a .35mm (#80 / .0135") diameter drill and have a final plated thru diameter of .25 mm (.010").
- Add as much copper as possible to inner and outer layers near the part to ensure optimal thermal performance.
- Mounting screws can be added near the part to fasten the board to a heatsink. Ensure that the ground / thermal via region contacts the heatsink.
- Do not put solder mask on the backside of the PC board in the region where the board contacts the heatsink.
- RF trace width depends upon the PC board material and construction.
- Use 1 oz. Copper minimum.
- All dimensions are in millimeters (inches). Angles are in degrees.

### Typical Device S-Parameters

S-Parameters ( $V_{\text{device}} = +3.4 \text{ V}$ ,  $I_{\text{CC}} = 30 \text{ mA}$ ,  $T = 25^\circ\text{C}$ , calibrated to device leads)

| Freq (MHz) | S11 (dB) | S11 (ang) | S21 (dB) | S21 (ang) | S12 (dB) | S12 (ang) | S22 (dB) | S22 (ang) |
|------------|----------|-----------|----------|-----------|----------|-----------|----------|-----------|
| 50         | -33.58   | 15.96     | 22.85    | 178.01    | -24.47   | -1.35     | -28.60   | 3.58      |
| 500        | -24.53   | 12.09     | 22.63    | 162.01    | -24.14   | 1.89      | -22.29   | -35.35    |
| 1000       | -32.76   | 32.44     | 22.20    | 144.90    | -23.99   | 4.76      | -25.75   | -100.14   |
| 1500       | -28.56   | 153.22    | 21.54    | 129.42    | -23.56   | 7.59      | -20.80   | -165.24   |
| 2000       | -25.13   | 172.50    | 20.74    | 114.94    | -23.12   | 9.11      | -17.59   | 175.89    |
| 2500       | -28.01   | -117.92   | 20.11    | 103.13    | -22.71   | 7.41      | -20.44   | 169.69    |
| 3000       | -28.65   | -133.85   | 19.33    | 91.28     | -22.14   | 7.37      | -18.13   | 154.41    |
| 3500       | -28.35   | -142.02   | 18.59    | 79.59     | -21.68   | 4.16      | -16.41   | 140.24    |
| 4000       | -25.99   | -171.80   | 17.77    | 68.13     | -20.88   | 2.49      | -14.29   | 124.73    |
| 4500       | -22.91   | 160.22    | 17.05    | 57.38     | -20.50   | 2.47      | -12.47   | 116.41    |
| 5000       | -19.69   | 153.85    | 16.39    | 48.12     | -20.03   | -0.55     | -11.36   | 113.60    |
| 5500       | -17.30   | 152.52    | 15.78    | 39.49     | -19.55   | -5.36     | -11.30   | 114.22    |
| 6000       | -15.88   | 144.43    | 15.21    | 30.49     | -19.14   | -6.76     | -11.31   | 113.24    |

Device S-parameters are available for download from the website at: [www.TriQuint.com](http://www.TriQuint.com)